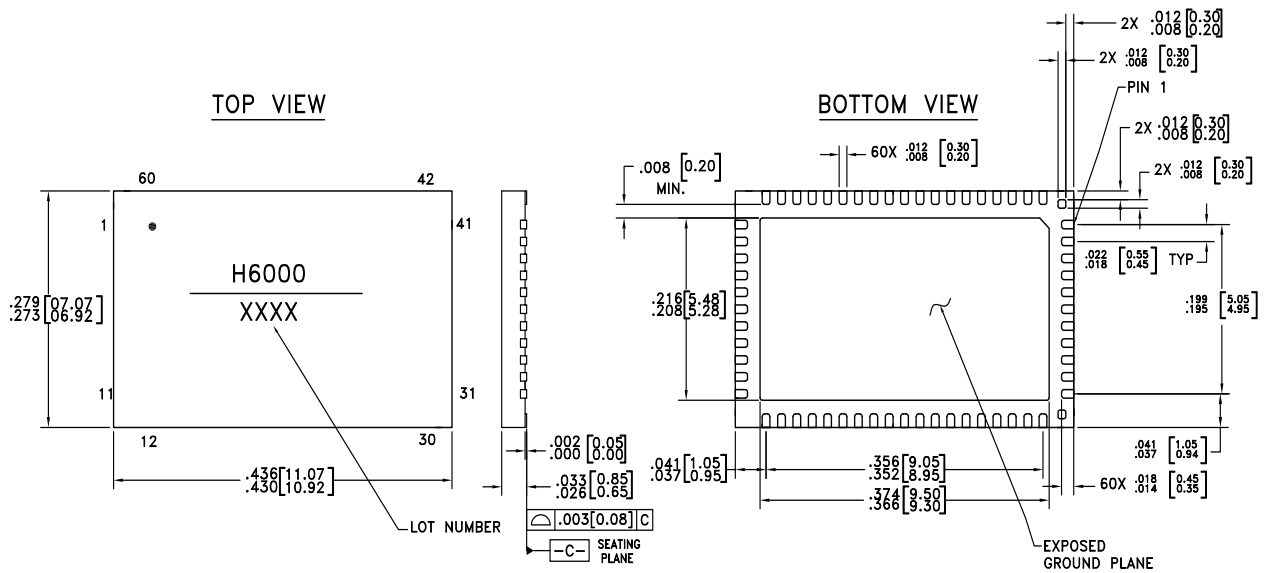


**LP711 (E) – 60 LEAD 7x11  
(QFN) PLASTIC PACKAGE: 77mm<sup>2</sup>**

**LP711 (E) PCB Outline Drawing**

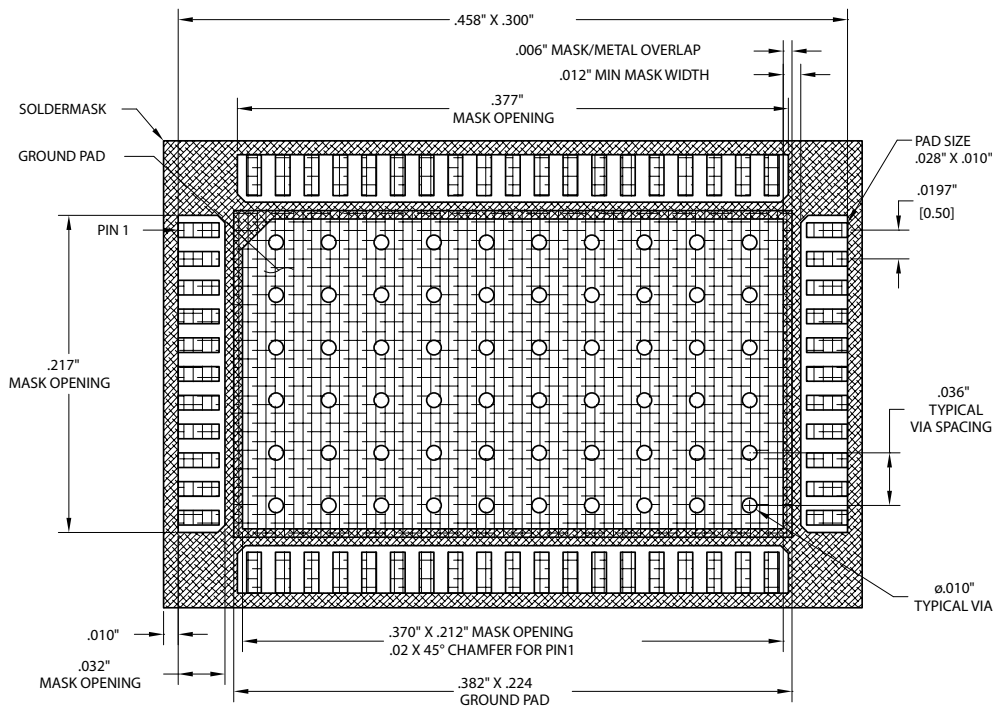
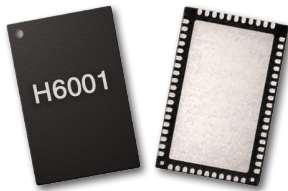


**NOTES:**

1. ALL DIMENSIONS ARE IN INCHES [MM]
2. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
3. PAD BURR LENGTH SHALL BE 0.15 mm MAX. PAD BURR HEIGHT SHALL BE 0.05 mm MAX.
4. PACKAGE WARP SHALL NOT EXCEED 0.05 mm
5. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND
6. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED PCB LAND PATTERN.

## LP711 (E) – 60 LEAD 7x11 (QFN) PLASTIC PACKAGE: 77mm<sup>2</sup>

### Suggested LP711 (E) PCB Land Pattern



**Table 1. Package Information**

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking
HMC6001LP711E	RoHS-compliant Low Stress Injection Molded Plastic Silica and Silicon	100% matte Sn	MSL3	<u>H6001</u> XXXX

[1] 4-Digit lot number XXXX